INolux 5050 RGB LED
4-Pin With Integrated IC
IN-PI554FCH

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Product Specifications

	Specification	Material	Quantity
Iv	Red ：550mcd typ. Green ：1250mcd typ. Blue ：300mcd typ. @12mA/ Ta= 25°C; Tolerance ±10%		
λD	Red ：624nm typ. Green ：524nm typ. Blue ：466nm typ. @12mA/ Ta= 25° C; Tolerance ± 0.5nm		
Vf	Red ：1.8-2.2 V Green ：2.8-3.2 V Blue ：2.8-3.2 V @12mA/ Ta= 25°C; Tolerance ± 0.05V		
Resin	Clear	Epoxy Resin	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	1000pc/reel
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

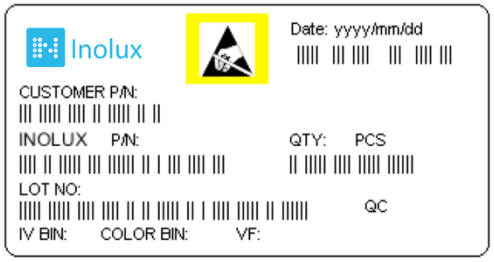
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Specifications



■ INolux P/N:

I N - P I 5 5 4 F C H - X X X X

Product	Package	Color	Customer Code
IN: INolux Corporation	PI55: 5.0 (L) x 5.0 (W) x1.6 (H) mm 4: 4-Pin Version	FCH: Full Color	XXXX: Customer Specific Code

Features

1. 5050 with integrated high quality constant current IC and RGB LED chip.
2. Built-in IC, with high precision of constant current and internal RGB chips spectral processing in advance.
3. Single line data transmission（return to zero code）.
4. Specific Shaping Transmit Technology - number of LED stacked is not restricted.
5. Cascading Enhancement Technology - any 2 LED spacing can be up to 10 meters
6. Data transfer rate of 800 kbp/s at 30 frames per second.
7. RGB output port PWM control can achieve 256 grey level adjustments
9. Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
10. SA-I Anti-interference patent technology for single line data transmission.
11. Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

LED Characteristics

(T_a=-25°C, unless otherwise specified)

Light color	Wavelength（nm）	Light intensity（mcd）	Working current（mA）	Working voltage（V）
R	620-625	400-700	12	1.8-2.2
G	520-525	1000-1500	12	2.8-3.2
B	465-470	200-400	12	2.8-3.2

Recommended Operating Ranges

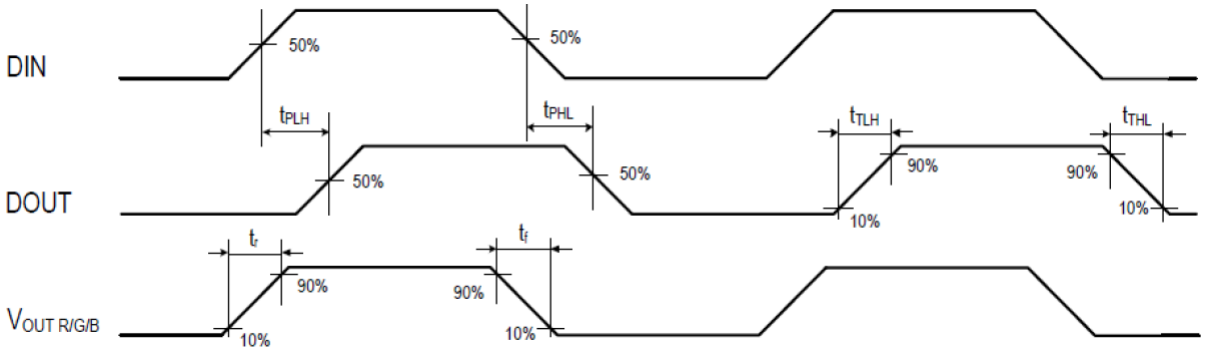
(T_a=-25°C, unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max	Unit	Test conditions
Supply voltage	*VDD*	-	5.2	-	V	-
High level input voltage	*VIH*	0.7*VDD	-		V	VDD=5.0V
Low level input voltage	*VIL*	-	-	0.3*VDD	V	VDD=5.0V
The frequency of PWM	*FPWM*	-	1.0	-	KHZ	-
Static power consumption	*IDD*	-	0.5	-	mA	-

Switching Characteristics

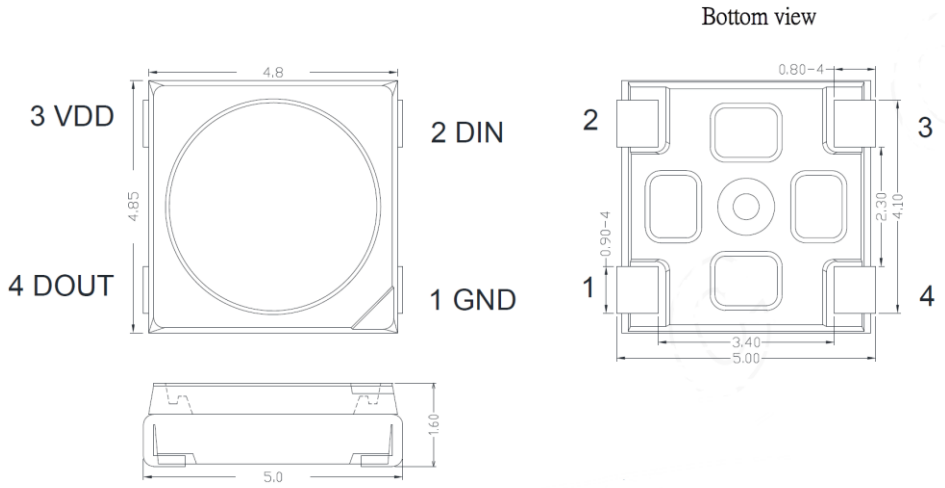
(T_a=-25°C, unless otherwise specified)

Parameter	Symbol	Min	Typical	Max	Unit	Test conditions
The speed of data transmission	fDIN	---	800	---	KHZ	The duty ratio of 67% (data 1)
DOUT transmission delay	TPLH	---	67	---	ns	The earth load capacitance of the dout port is 30pf, and the signal transmission delay from DIN to dout
	TPHL	---	82	---	ns	
Out R/B conversion time	Tr	---	22	---	ns	IOUT R / B= 5mA, out R / B port connected with 200 Ω resistor to VDD in series, load capacitance to ground
	Tf	---	75	---	ns	
Out G conversion time	Tr	---	18	---	ns	IOUT g = 5mA, out g port is connected with 200 Ω resistor to VDD in series, and the load capacitance to ground is 30pf
	Tf	---	110	---	ns	

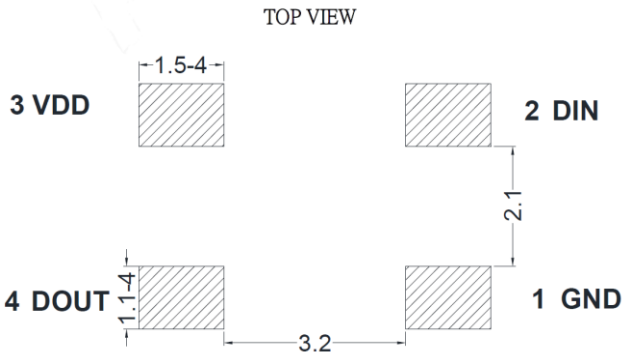


Package Outline Dimension & Recommended dimensions for PCB products

Outline Dim.



Recommended dimensions for PCB products



Soldering terminals may shift in the x, y direction. Unit: mm Tolerance: +/-0.1mm

PIN Description

Number	Symbol	Function Description
1	GND	Ground
2	DIN	Control data signal input
3	VDD	Power Supply LED
4	DOUT	Control data signal output

Absolute Maximum Ratings

(T_a = 25 °C, V_{ss}=0V, unless otherwise specified)

Parameter	Symbol	Range	Unit
Logic supply voltage	V_{DD}	+3.7～+5.5	V
Logic input voltage	V_{IN}	-0.5~V_{DD}+0.5	V
Operating temperature	T_{OPT}	−40 to +85	℃
Storage temperature	T_{STG}	−40 to +85	℃
ESD pressure	V_{ESD}	2K	V

Functional Description

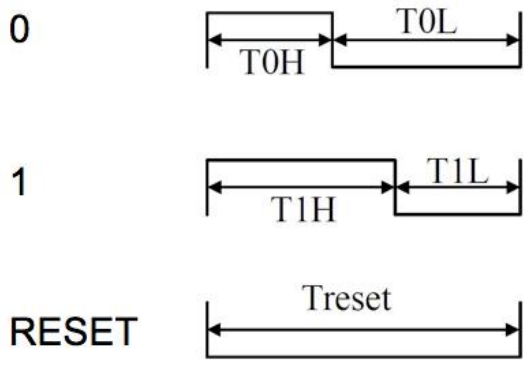
The IN-PI554FCH sends signals in return to zero codes with a single-wire communication method.

When the power-on reset is completed, the IN-PI554FCH receives the data from the DIN pin.

When all the 24 bits of data have been received, IC no longer receive data, the DOUT port starts to forward the data to the next chip as its input data. The DOUT pin is held LOW before the data forwarding. The three PWM output ports, OUTR, OUTG and OUTB, drive Duty ratio output in a 0.6-ms period corresponding to the 24-bit data received before. If the input data from the DIN pin is a RESET code, the IN-PI554FCH will drive the newest received 24-bit data for display. When the reset code is completed, the IN-PI554FCH will start receive the new 24-bit data. When 24 bits of data have been received, the IN-PI554FCH will forward the data through the DOUT pin. Before the RESET signal is received, the output at the OUTR, OUTG and OUTB pins will remain unchanged. When a low level RESET code longer than 80μs is received, the IN-PI554FCH will drive Duty ratio output corresponding to the newest 24-bit data received The IN-PI554FCH employs an automatic shaping-forwarding technique, so the number of the cascaded chips is not limited by the signal transfer, and is only limited by the panel refresh speed. For example, in a 1024-chip cascaded design with the panel refresh time of 1024X3X8 X 1.25（us）=30ms, no flickering will appear.

Timing Waveforms

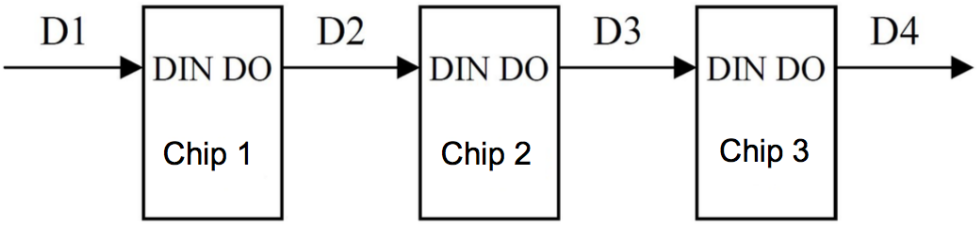
1. Input Code



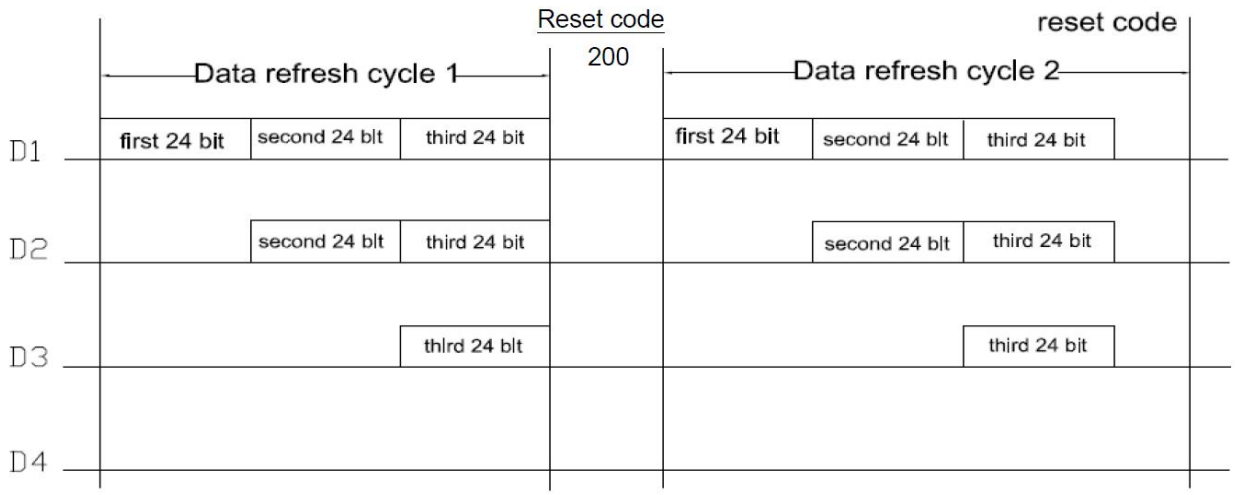
2. The data transmission time (TH+TL=1.25μs±600ns):

Name		Min.	Standard value	Max.	Unit
T	Code period	1.20	--	--	μs
T0H	0 code, high level time	0.20	0.30	0.40	μs
T0L	0 code, low level time	0.80	--	--	μs
T1H	1 code, high level time	0.70	0.90	1.00	μs
T1L	1 code, low level time	0.20	--	--	μs
Trst	Reset code，low level time	200	--	--	μs

3. Connection Scheme



4. Data Transfer Format

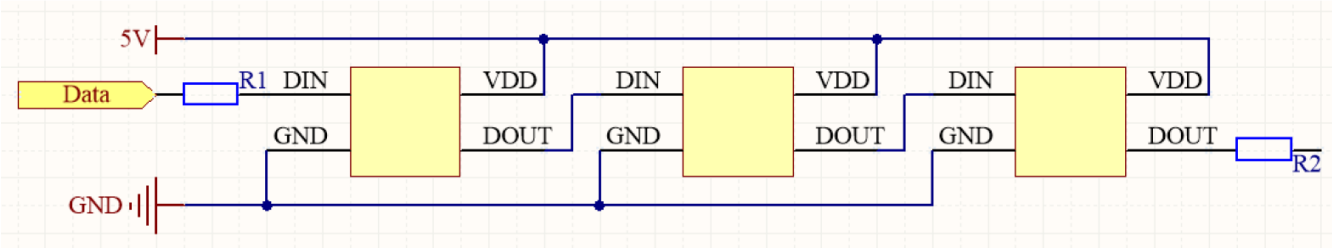


5. 24-bit data format

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
R3	R2	R1	R0	B7	B6	B5	B4	B3	B2	B1	B0

Note: high starting, in order to send data (G7 - G6 - ....B0)

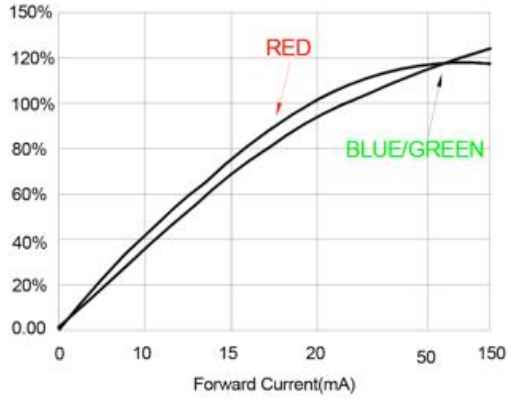
Typical Application circuit diagram



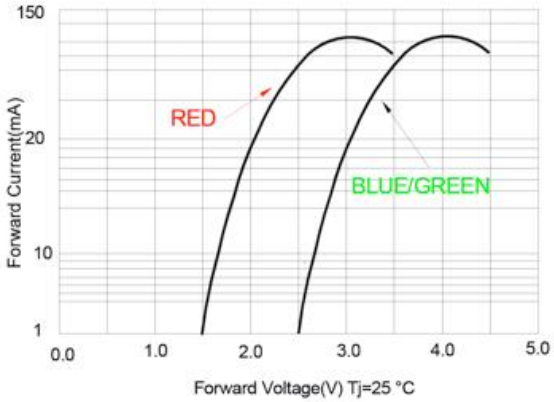
Application: used for soft lamp strip or hard light, lamp beads transmission distance is short, suggested in signal in time the clock line input and output end of each connected in series protection resistors, R1=R2 of about 500 ohms.

LED Performance Graph

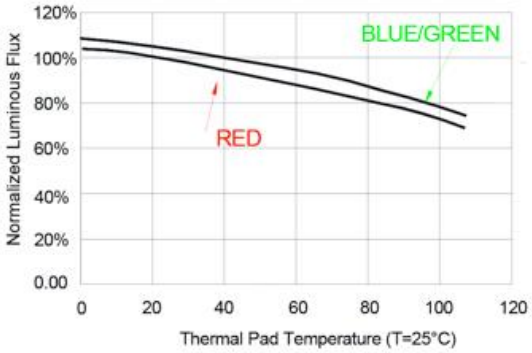
Typical Relative Luminous Flux vs. Forward Current



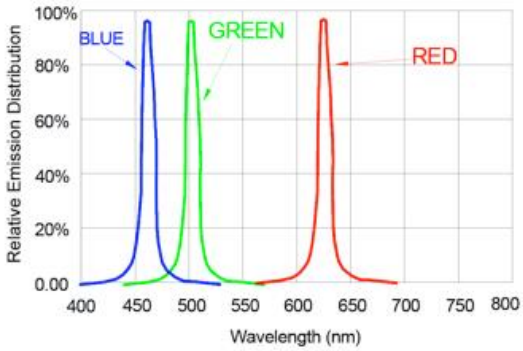
Forward Voltage vs. Forward Current



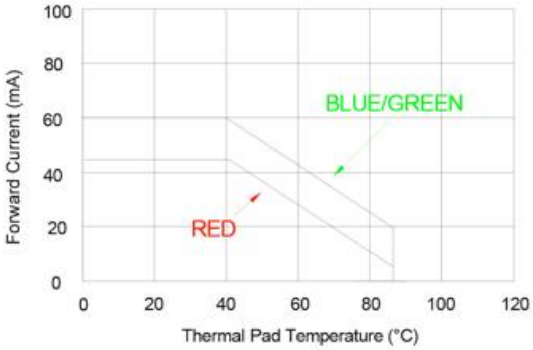
Thermal Pad Temperature vs. Relative Light Output



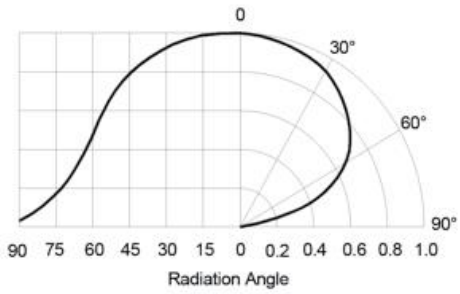
Wavelength Characteristics



Thermal Pad Temperature vs. Forward Current



Typical Radiation Pattern 120°



Precautions

Please read the following notes before using the product:

1. Storage

1.1 Do not open moisture proof bag before the products are ready to use.

1.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.

1.3 The LEDs should be used within a year.

1.4 After opening the package, the remaining LEDs should be kept in a resealed bag.

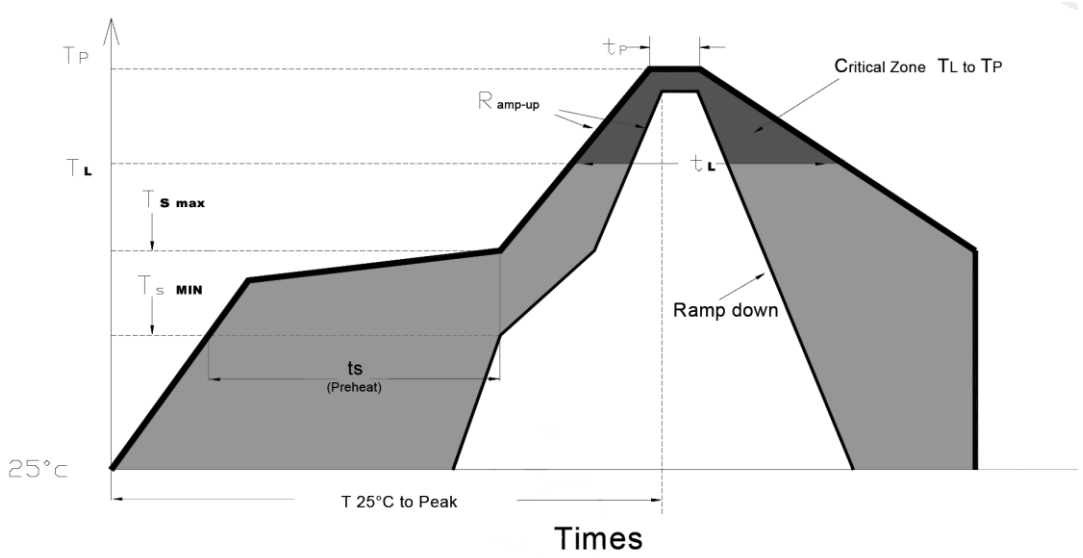
1.5 The LEDs require mandatory baking before usage. Baking treatment listed below.

1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

*Baking treatment: 60±5℃ for24 hours.

2. Soldering Condition

Recommended soldering conditions:



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts_{max} to Tp)	3℃/second max.
Preheat: Temperature Min (Ts_{min})	150℃
Preheat: Temperature Min (Ts_{max})	200℃
Preheat: Time (ts_{min} to ts_{max})	60-180 seconds
Time Maintained Above: Temperature (T_L)	217 ℃
Time Maintained Above: Time (t_L)	60-150 seconds
Peak/Classification Temperature (T_P)	240 ℃
Time Within 5℃ of Actual Peak Temperature (tp)	<10 seconds
Ramp-Down Rate	6℃/second max.
Time 25 ℃ to Peak Temperature	<6 minutes max.

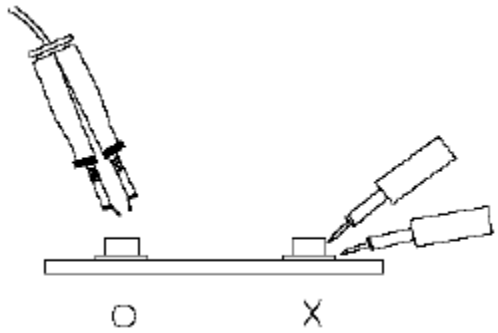
Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260℃ for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial release	-	1.0	12-21-2015
Update optical electrical characteristics		2.0	06-10-2016
Update data transmission time / intensity level/ handling		2.1	10-20-2016
Update intensity level		2.2	10-31-2016
Update intensity level		2.3	01-07-2019
Revise the drawing; revise the precaution.	14, 16	2.4	07-31-2019
Revise the drawing	P7~P12	2.5	02-04-2021